

Solutia formulation No. EPWD 0806 / today Cytec

07/99

FUNCTION	PRODUCT	PRODUCER	PBW
Component A			
Curing agent	Beckopox EH 623 w/80 WA	Solutia, today Cytec	11.00
Dispersing agent	Additol VXW 6208	Solutia, today Cytec	0.25
Wetting agent	Surfynol SE-F	Air Products	0.25
	Water		11.00
Premix.			
Anticorrosive pigment	HEUCOPHOS® ZPA	Heubach	7.25
Carbon black	Printex 300	Degussa, today Evonik	0.15
Iron oxide black	Bayferrox 306	Bayer	5.10
Magnesium silicate	Micro-Talc I.T. Extra	Mondo Minerals	7.30
Antisettling agent	Aerosil R 972	Degussa, today Evonik	0.25
Grind with a bead mill, temperature < 104°F.			
	Water		7.45
Add while mixing.			
			50.00
Component B			
Epoxy dispersion	Beckopox EP 385 w/56 WA	Solutia, today Cytec	50.00
Add.			
			50.00
Mix components A and B thoroughly prior to use.			
			100.00

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